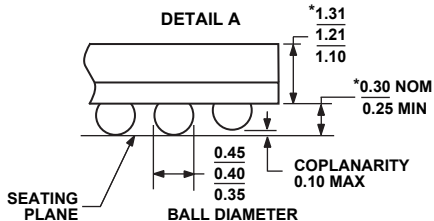
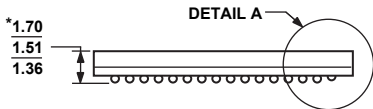
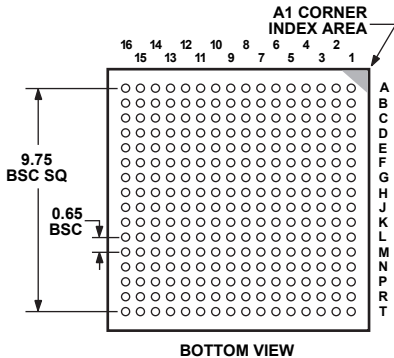
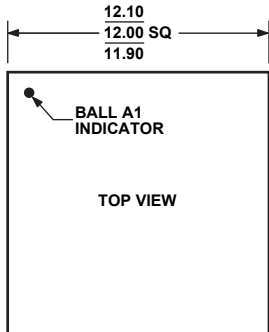


**256-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]  
(BC-256-1)**

Dimensions shown in millimeters



\*COMPLIANT TO JEDEC STANDARDS MO-225 WITH EXCEPTION TO DIMENSIONS INDICATED BY AN ASTERISK.